

High Speed CAN-Transceiver with Stand-By Mode and Bus wake-up

Data Sheet

Rev. 1.0, 2011-11-4

Standard Power



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High Speed CAN-Transceiver with Stand-By Mode and Bus wake-up

IFX1040SJ



1 Overview

Features

- CAN data transmission rate up to 1 MBaud
- Compatible to ISO 11898-2 and ISO 11898-5
- · Low power mode with remote wake-up via CAN bus
- Wake signaling by RxD toggle
- No BUS load in stand-by mode
- Wide common mode range for electromagnetic immunity (EMI)
- Digital inputs compatible to 3.3 and 5 V logic devices
- Split termination to stabilize the recessive level
- TxD time-out function
- Overtemperature protection
- Green Product (RoHS compliant)

Description

The CAN-transceiver IFX1040SJ is a monolithic integrated circuit in a PG-DSO-8 package for high speed differential mode data transmission (up to 1 Mbaud) and reception in industrial applications. It works as an interface between the CAN protocol controller and the physical bus lines compatible to ISO Standard 11898-2 and ISO Standard 11898-5.

The IFX1040SJ is designed to provide an excellent passive behavior when the transceiver is switched off and a remote wake-up capability via CAN bus in low power mode. This supports networks with partially un-powered nodes.

The IFX1040SJ has two operation modes, the normal and the stand-by mode. These modes can be chosen by the STB pin. If the IFX1040SJ is in stand-by mode and a message on the bus is detected, the IFX1040SJ changes the level at the RxD pin corresponding to the bus signal (wake-up flag).

The IFX1040SJ is designed to withstand the severe conditions of industrial applications.

Туре	Package	Marking
IFX1040SJ	PG-DSO-8	1040SJ



PG-DSO-8



Pin Configuration

2 Pin Configuration

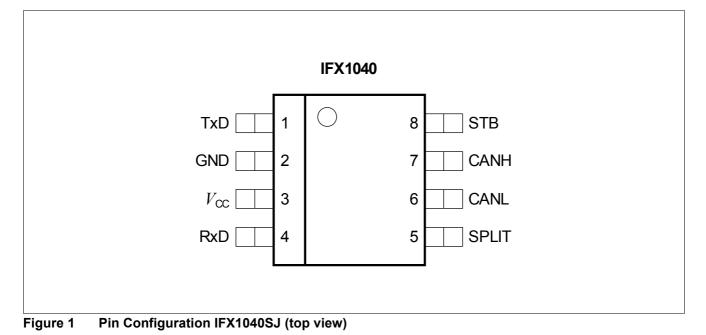


Table 1 Pin Definitions and F	unctions IFX1040SJ
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Pin No.	Symbol	Function
1	TxD	CAN transmit data input ; 20 k Ω pull-up, LOW in dominant state
2	GND	Ground
3	V _{CC}	5 V Supply input; 100 nF decoupling capacitor required
4	RxD	CAN receive data output; LOW in dominant state,
5	SPLIT	Split termination output; to support the recessive voltage level of the bus lines
6	CANL	Low line I/O; LOW in dominant state
7	CANH	High line I/O; HIGH in dominant state
8	STB	Mode Control Input; Internal pull-up, see Figure 3



Block Diagram

3 Block Diagram

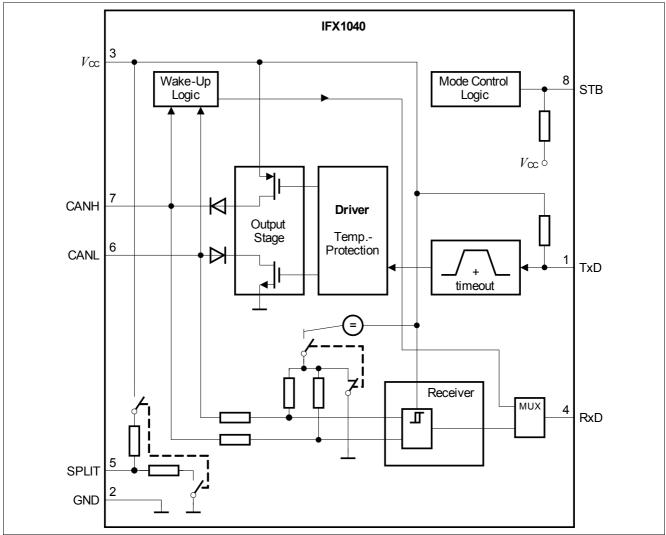


Figure 2 Block Diagram IFX1040SJ



Application Information

4 Application Information

The IFX1040SJ has two operation modes, the normal and the standby mode. These modes can be controlled with the STB pin (see Figure 3, Table 2). The STB pin has an implemented pull-up, so if there is no signal applied to STB or STB = HIGH, the standby mode is activated. To transfer the IFX1040SJ into the normal mode, STB has to be switched to LOW.

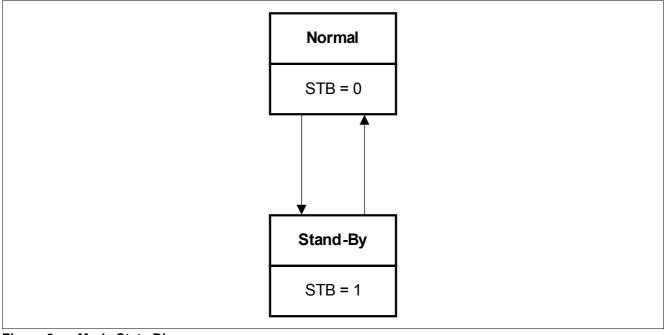


Figure 3 Mode State Diagram

Table 2Truth Table

Mode	STB	Event	RxD	BUS Termination
Normal	low	bus dominant	low	V _{CC} /2
		bus recessive	high	
Stand by	high	wake-up via CAN bus detected	low/high ¹⁾	GND
		no wake-up detected	high	

1) Signal at RxD changes corresponding to the bus signal during stand by mode. See Figure 6

Normal Mode

This mode is designed for the normal data transmission/reception within the HS-CAN network.

Transmission

The signal from the μ C is applied to the TxD input of the IFX1040SJ. Now the bus driver switches the CANH/L output stages to transfer this input signal to the CAN bus lines.



Application Information

TxD Time-out Feature

If the TxD signal is dominant for a time $t > t_{TxD}$ the TxD time-out function deactivates the transmitter of the IFX1040. This is realized to prevent the bus from being blocked permanently dominant due to an error like in case of a malfunctioning microcontroller.

The transmission is released again, after a rising edge at TxD has been detected.

As a result of the TxD Time-Out function, the minimum bit rate is limited. The minimum achievable bit rate can be calculated by the maximum number of consecutive dominant bits allowed in the system. It is given by the maximum number of dominant bits allowed in the system divided by the TxD permanent dominant disable time t_TxD.

Reduced Electromagnetic Emission

The bus driver has an implemented control to reduce the electromagnetic emission (EME). This is achieved by controlling the symmetry of the slope, resp. of CANH and CANL.

Overtemperature

The driver stages are protected against overtemperature. Exceeding the shutdown temperature results in deactivation of the driving stages at CANH/L. To avoid a bit failure after cooling down, the signals can be transmitted again only after a dominant to recessive edge at TxD.

Figure 4 shows the way how the transmission stage is deactivated and activated again. First an over temperature condition causes the transmission stage to deactivate. After the over temperature condition is no longer present, the transmission is only possible after the TxD signal has changed to recessive level.

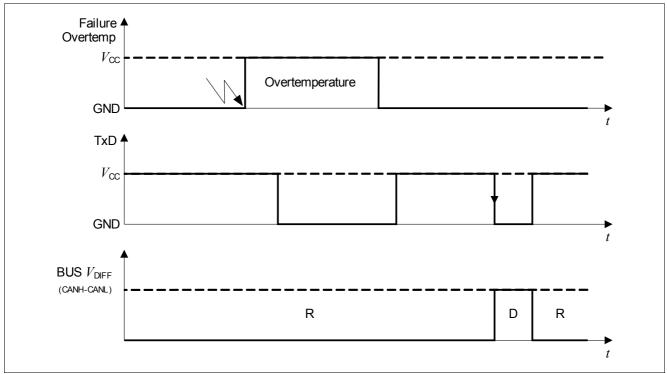


Figure 4 Release of the Transmission after Overtemperature

Reception

The analog CAN bus signals are converted into a digital signal at RxD via the differential input receiver. The RxD signal is switched to RxD output pin via the multiplexer (MUX), see Figure 2.

In normal mode the split pin is used to stabilize the recessive common mode signal.



Standby Mode

The standby mode is designed to switch the IFX1040SJ into a low power mode with minimum current consumption. The driving stages and the receiver are deactivated. Only the relevant circuitry to guarantee a correct handling of the CAN bus wake-up is still active. This wake-up receiver is also designed to show an excellent immunity against electromagnetic noise (EMI).

Change into Standby Mode during CAN Bus Failure

It is possible to change from normal mode into the standby mode if the bus is dominant due to a bus failure without setting the RxD wake flag to LOW. The advantage is, that the IFX1040SJ can be kept in the standby mode even if a bus failure occurs.

Figure 5 shows this mechanism in detail. During a bus network failure, the bus might be dominant. Normal communication is not possible until the failure is removed. To reduce the current consumption, it makes sense to switch over to standby mode. This is possible with the IFX1040SJ. If the dominant signal switches back to recessive level, e.g. failure removed, a wake-up via CAN bus (recessive to dominant signal detected) is possible.

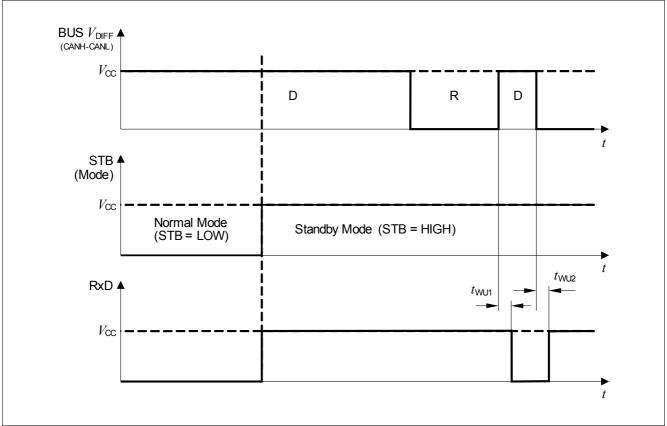


Figure 5 Go-To Standby Mode during Bus Dominant Condition



Application Information

Wake-up via CAN Message

During standby mode, a dominant CAN message on the bus longer than the filtering time $t > t_{WU1}$, leads to the activation of the wake-up. The wake-up during standby mode is signaled with the RxD output pin. A dominant signal longer $t > t_{WU1}$ on the CAN bus switches the RxD level to LOW, with a following recessive signal on the CAN bus longer $t > t_{WU2}$ the RxD level is switched to high, see Figure 6.

The μ C is able to detect this change at RxD and switch the transceiver into the normal mode.

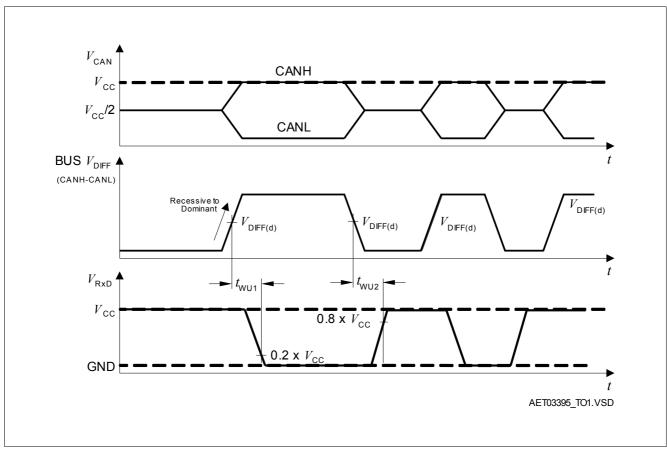


Figure 6 Wake-up behavior



Application Information

Split Circuit

The split circuitry is activated during normal mode and deactivated (SPLIT pin floating) during standby mode. The SPLIT pin is used to stabilize the recessive common mode signal in normal mode. This is realized with a stabilized voltage of 0.5 V_{CC} at SPLIT.

A correct application of the SPLIT pin is shown in **Figure 7**. The split termination for the left and right node is realized with two 60 Ω resistances and one 10 nF capacitor. The center node in this example is a stub node and the recommended value for the split resistances is 1.5 k Ω .

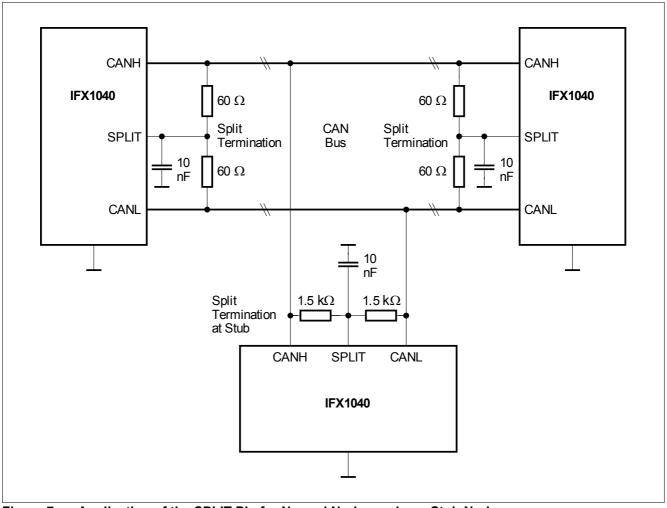


Figure 7 Application of the SPLIT Pin for Normal Nodes and one Stub Node

Other Features

Fail Safe

If the device is supplied but there is no signal at the digital inputs, the TxD and STB have an internal pull-up path, to prevent the transceiver to switch into the normal mode or send a dominant signal on the bus.

Un-supplied Node

The CANH/CANL pins remain high ohmic, if the transceiver is un-supplied.



5 Electrical Characteristics

Table 3 Absolute Maximum Ratings

Parameter	Symbol	Limit Values		Unit	Remarks	
		Min. Max.				
Voltages						
Supply voltage	V _{CC}	-0.3	5.5	V	-	
CAN bus voltage (CANH, CANL)	$V_{\rm CANH/L}$	-32	40	V	-	
CAN bus differential voltage CANH, CANL, SPLIT	$V_{CAN diff}$	-40	40	V	CANH - CANL < 40 V CANH - SPLIT < 40 V CANL - SPLIT < 40 V	
Input voltage at SPLIT	$V_{\rm SPLIT}$	-27	40	V	-	
Logic voltages at STB, TxD, RxD	V_1	-0.3	V _{cc}	V	0 V < V _{CC} < 5.5 V	
Electrostatic discharge voltage at CANH, CANL, SPLIT vs. GND	V _{ESD}	-6	6	kV	Human Body Model (100 pF via 1.5 kW)	
Electrostatic discharge voltage	V _{ESD}	-2	2	kV	Human Body Model (100 pF via 1.5 kW)	
Temperatures						
Junction Temperature	Tj	-40	150	°C	-	
Storage Temperature	T _{stg}	-50	150	°C	_	

Note: Maximum ratings are absolute ratings; exceeding any one of these values may cause irreversible damage to the integrated circuit.

5.1 Operating Range

Table 4Operating Range

Parameter	Symbol	Lim	it Values	Unit	Remarks
		Min.	Max.		
Supply voltage	V _{CC}	4.75	5.25	V	-
Junction temperature	T	-40	125	°C	-
Thermal Resistances		1		l	
Junction ambient	$R_{ m thj-a}$	_	185	K/W	1)
Thermal Shutdown (junction temperature		-+	ŀ		+
Thermal shutdown temperature	$T_{\sf jsD}$	150	190	°C	-
Thermal shutdown hyst.	ΔT	-	10	К	_

1) Calculation of the junction temperature $T_j = T_{amb} + P \times R_{thj-a}$



Table 5 Electrical Characteristics

4.75 V < V_{CC} < 5.25 V; R_{L} = 60 Ω ; -40 °C < T_{j} < 125 °C; all voltages with respect to ground; positive current flowing into pin; unless otherwise specified.

Parameter	Symbol	L	imit Va	lues	Unit	Remarks	
		Min.	Тур.	Max.			
Current Consumption							
Current consumption	I _{CC}	-	6	10	mA	recessive state; $V_{\text{TxD}} = V_{\text{CC}}$	
Current consumption	I _{CC}	-	45	70	mA	dominant state; $V_{TxD} = 0 V$	
Current consumption	$I_{\rm CC,stb}$	-	20	30	μA	stand-by mode; TxD = high	
Receiver Output RxD	ł	1			1		
HIGH level output current	$I_{\rm RD,H}$	-	-4	-2	mA	$V_{\rm RD}$ = 0.8 × $V_{\rm CC}$	
	,	-	-100	-	μA	stand-by mode	
LOW level output current	$I_{\rm RD,L}$	2	4	_	mA	$V_{\rm RD}$ = 0.2 × $V_{\rm CC}$	
Short circuit current	I _{SC,RxD}	-	15	20	mA	-	
Transmission Input TxD	00,00						
HIGH level input voltage threshold	V _{TD,H}	2.0	-	_	V	recessive state	
LOW level input voltage threshold	V _{TD,L}	_	-	0.8	V	dominant state	
TxD pull-up resistance	R _{TD}	10	20	40	kΩ	-	
TxD input hysteresis	V _{TD hys}	_	200	_	mV	_	
Stand By Input (pin STB)	12.1.90						
HIGH level input voltage threshold	V _{STB,H}	2.0	-	_	V	normal mode	
LOW level input voltage threshold	V _{STB,L}	_	_	0.8	V	receive-only mode	
STB pull-up resistance	R _{STB}	10	20	40	kΩ	_	
STB input hysteresis	V _{STB hys}	_	200	_	mV	-	
Split Termination Output (pin SPLIT)		ļ		-+	Į		
Split output voltage	V _{SPLIT}	$0.3 \times V_{CC}$	$0.5 \times V_{CC}$	$0.7 \times V_{CC}$	V	normal mode; -500 μA < I _{SPLIT} < 500 μA	
	V _{SPLIT}	$0.45 \times V_{CC}$	0.5 ×	0.55× V _{CC}	V	normal mode; no Load	
Leakage current	I _{SPLIT}	-5	0	5	μA	standby mode; -22 V < V _{SPLIT} < 35 V	
SPLIT output resistance	R _{SPLIT}	_	600	_	Ω	-	
Bus Receiver	ł	1			1		
Differential receiver threshold voltage,	$V_{\rm diff,rdN}$	-	0.8	0.9	V	recessive to dominant	
normal mode	V _{diff,drN}	0.5	0.6	_	V	dominant to recessive	
Differential receiver threshold,	V _{diff,rdLP}		0.9	1.15	V	recessive to dominant	
low power mode	V _{diff,drLP}	0.4	0.8		V	dominant to recessive	
Common Mode Range	CMR	-12	-	12	V	V _{CC} = 5 V	
Differential receiver hysteresis	V _{diff,hys}	-	200	-	mV	-	
CANH, CANL input resistance	R _i	10	20	30	kΩ	recessive state	
Differential input resistance	R _{diff}	20	40	60	kΩ	recessive state	



Table 5 Electrical Characteristics (cont'd)

4.75 V < V_{CC} < 5.25 V; R_{L} = 60 Ω ; -40 °C < T_{j} < 125 °C; all voltages with respect to ground; positive current flowing into pin; unless otherwise specified.

Parameter	Symbol	Limit Values			Unit	Remarks	
		Min. Typ.		Max.			
Bus Transmitter				L		1	
CANL/CANH recessive output voltage	$V_{CANL/H}$	2.0	2.5	3.0	V	$V_{\text{TxD}} = V_{\text{CC};}$ no load	
CANH, CANL recessive output voltage difference	V _{diff}	-500	-	50	mV	$V_{\text{TxD}} = V_{\text{CC}};$ no load	
CANL dominant output voltage	V _{CANL}	0.5	-	2.25	V	$V_{\text{TxD}} = 0 \text{ V};$ $V_{\text{CC}} = 5 \text{ V}$	
CANH dominant output voltage	V _{CANH}	2.75	-	4.5	V	$V_{\text{TxD}} = 0 \text{ V};$ $V_{\text{CC}} = 5 \text{ V}$	
CANH, CANL dominant output voltage difference	V _{diff}	1.5	-	3.0	V	$V_{TxD} = 0 V;$ $V_{CC} = 5 V$	
$V_{\text{diff}} = V_{\text{CANH}} - V_{\text{CANL}}$							
CANL short circuit current	I_{CANLsc}	50	80	200	mA	$V_{\text{CANLshort}} = 18 \text{ V}$	
CANH short circuit current	I_{CANHsc}	-200	-80	-50	mA	$V_{\text{CANHshort}} = 0 \text{ V}$	
Leakage current	$I_{\rm CANH,L,lk}$	-	-	-5	μA	$V_{\rm CC}$ = 0 V; 0 V < $V_{\rm CANH,L}$ < 5 V	
Dynamic CAN-Transceiver Characteristic	s						
Propagation delay TxD-to-RxD LOW (recessive to dominant)	t _{d(L),TR}	-	150	255	ns	$C_{L} = 47 \text{ pF};$ $R_{L} = 60 \Omega;$ $V_{CC} = 5 \text{ V};$ $C_{RxD} = 15 \text{ pF}$	
Propagation delay TxD-to-RxD HIGH (dominant to recessive)	t _{d(H),TR}	-	150	255	ns	$C_{L} = 47 \text{ pF};$ $R_{L} = 60 \Omega;$ $V_{CC} = 5 \text{ V};$ $C_{RxD} = 15 \text{ pF}$	
Propagation delay TxD LOW to bus dominant	t _{d(L),T}	-	50	120	ns	$C_{L} = 47 \text{ pF};$ $R_{L} = 60 \Omega;$ $V_{CC} = 5 \text{ V}$	
Propagation delay TxD HIGH to bus recessive	t _{d(H),T}	-	50	120	ns	$C_{\rm L} = 47 \text{ pF};$ $R_{\rm L} = 60 \Omega;$ $V_{\rm CC} = 5 \text{ V}$	
Propagation delay bus dominant to RxD LOW	t _{d(L),R}	_	100	135	ns	C_{L} = 47 pF; R_{L} = 60 Ω; V_{CC} = 5 V; C_{RxD} = 15 pF	
Propagation delay bus recessive to RxD HIGH	t _{d(H),R}	-	100	135	ns	$C_{\rm L} = 47 \text{ pF};$ $R_{\rm L} = 60 \Omega;$ $V_{\rm CC} = 5 \text{ V};$ $C_{\rm RxD} = 15 \text{ pF}$	
Min. dominant time for bus wake-up signal (RxD high to low)	t _{WU1}	0.75	3	5	μs	$t_{WU1} = t_{d(L),R} + t_{WU}$ see Figure 6	



Table 5 Electrical Characteristics (cont'd)

4.75 V < V_{CC} < 5.25 V; R_L = 60 Ω ; -40 °C < T_j < 125 °C; all voltages with respect to ground; positive current flowing into pin; unless otherwise specified.

Parameter	Symbol	Limit Values			Unit	Remarks	
		Min.	Тур.	Max.			
Min. recessive time for bus wake-up signal (RxD low to high)	t _{WU2}	0.75	3	5	μs	$t_{WU2} = t_{d(H),R} + t_{WU}$ see Figure 6	
TxD permanent dominant disable time	t _{TxD}	0.3	-	1.0	ms	-	



Diagrams

6 Diagrams

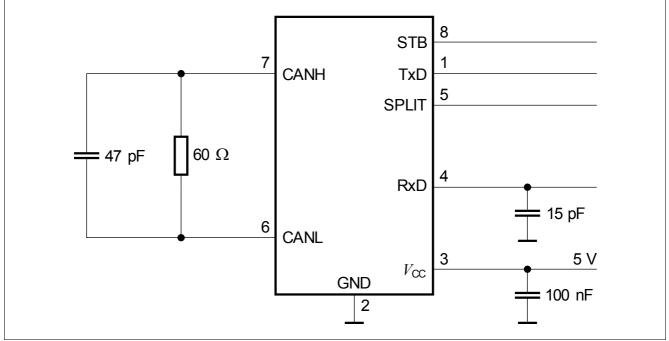


Figure 8 Test Circuit for Dynamic Characteristics



Diagrams

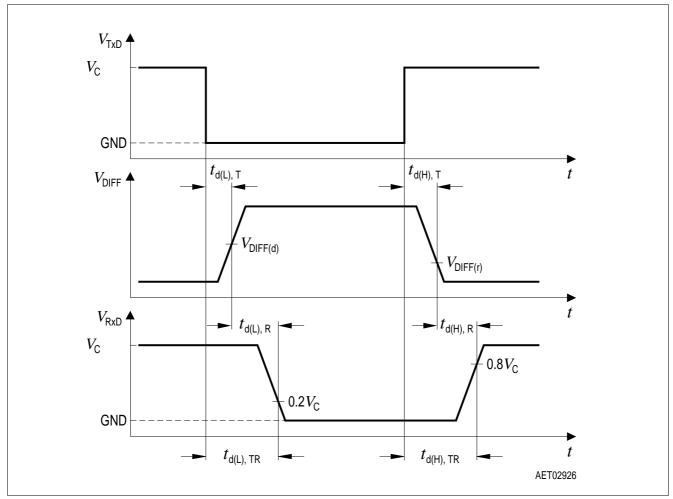


Figure 9 Timing Diagrams for Dynamic Characteristics



Application

7 Application

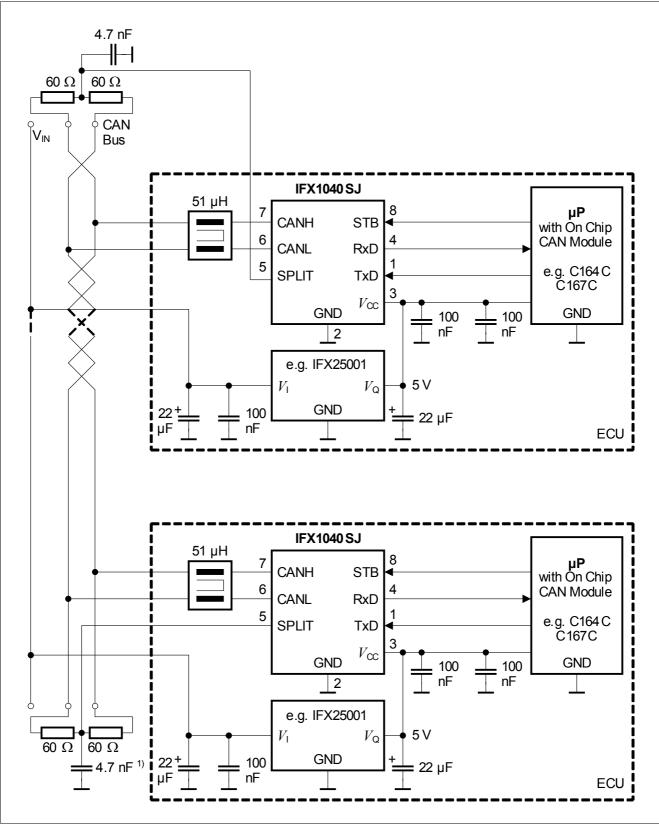
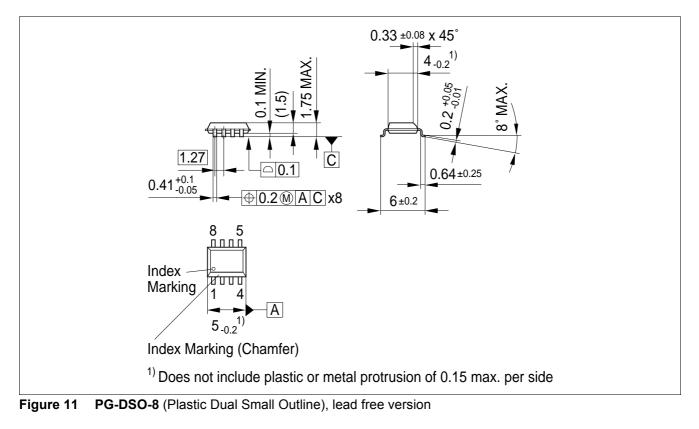


Figure 10 Application Circuit



Package Outlines

8 Package Outlines



Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).



Revision History

9 Revision History

Revision	Date	Changes
1.0	2011-11-04	Data Sheet

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